



CEDA 7000.5  
PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Application of Brian Lewis et al.  
Serial No. 10/722,288  
Filed November 25, 2003  
For THERMAL INTERFACE MATERIAL AND SOLDER PREFORMS

June 22, 2004

COMMISSIONER FOR PATENTS  
P.O. BOX 1450  
ALEXANDRIA, VIRGINIA 22313-1450

SIR:

**SUPPLEMENTAL INFORMATION DISCLOSURE STATEMENT**

In accordance with 37.C.F.R. 1.97 and 1.98 and MPEP 609, and in compliance with the duty of disclosure set forth in 37 CFR 1.56, applicants submit the enclosed PTO/SB/08A for consideration by the Patent and Trademark Office in the above-entitled application and to be made of record therein.

Applicants enclose a copy of Ref. JP 05-070252 (Mitsubishi) listed on the attached form. Applicants do not enclose a copy of 5,907,474, pursuant to new PTO rules not requiring copies of U.S. patents.

Respectfully submitted,

A handwritten signature in cursive script, reading "Paul I. J. Fleischut".

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PIF/leb/crm  
\*enclosures

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PTO/SB/08A				<b>Complete if Known</b>	
<b>SUPPLEMENTAL INFORMATION DISCLOSURE STATEMENT BY APPLICANT</b>  Use as many sheets as necessary)				Application Number	10/722,288
				Filing Date	November 25, 2003
				Confirmation Number	9116
				First Named Inventor	Brian Lewis
				Group Art Unit	1725
				Examiner Name	To Be Assigned
Sheet	1	of	1	Attorney Docket No.	CEDA 7000.5

U.S. PATENT DOCUMENTS							
Examiner Initials*	Cite No. <sup>1</sup>	U.S. Patent Document		Name of Patentee or Applicant of Cited Document	Date of Publication of Cited Document MM-DD-YYYY		
		Number	Kind Code <sup>2</sup> (if known)				
	36	5,907,474		Dolbear	05-25-1999		
FOREIGN PATENT DOCUMENTS							
Examiner Initials*	Cite No. <sup>1</sup>	Foreign Patent Document			Name of Patentee or Applicant of Cited Document	Date of Publication of Cited Document MM-DD-YYYY	T <sup>6</sup>
		Office	Number <sup>4</sup>	Kind Code <sup>2</sup> (if known)			
	37	JP	05-070252	A2	Mitsubishi Materials Corp.	03/23/1993	
OTHER ART - NON PATENT LITERATURE DOCUMENTS							
Examiner Initials*	Cite No. <sup>1</sup>	Include name of the author (in CAPITAL LETTERS), title of the article (when appropriate), title of the item (book, magazine, journal, serial, symposium, catalog, etc.) date, page(s), volume-issue number(s), publisher, city and/or country where published.					T <sup>6</sup>

Examiner Signature		Date Considered	
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\*EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 609. Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.

<sup>1</sup>Unique citation designation number. <sup>2</sup>See attached Kinds of U.S. Patent Documents. <sup>3</sup>Enter Office that issued the document, by the two-letter code (WIPO Standard ST.3). <sup>4</sup>For Japanese patent documents, the indication of the year of the reign of the Emperor must precede the serial number of the patent document. <sup>5</sup>Kind of document by the appropriate symbols as indicated on the document under WIPO Standard ST. 16 if possible. <sup>6</sup>Applicant is to place a check mark here if English language Translation is attached or place an "A" here if English language abstract is attached..

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